

IN THE CLAIMS:

The text of all pending claims are set forth below. Cancelled and withdrawn claims are indicated with claim number and status only. The claims as listed below show added text with underlining and deleted text with ~~strikethrough~~. The status of each claim is indicated with one of (original), (currently amended), (previously amended), (cancelled), (withdrawn), (new), (previously added), (reinstated - formerly claim #), (previously reinstated), (re-presented - formerly dependent claim #) or, (previously re-presented). Please AMEND claims and ADD new claims, in accordance with the following:

1. (ORIGINAL) A housing preform comprised of a bendable plate member inside of which is formed electronic components and interconnects for electrically connecting said electronic components.
2. (ORIGINAL) A housing preform as set forth in claim 1, wherein said plate member is comprised of a flexible substrate and a flexible protective film burying and covering said electronic components.
3. (ORIGINAL) A housing preform as set forth in claim 1, wherein parts of said plate member scheduled to be bent are provided with reinforcements for preventing breakage of said interconnects.
4. (ORIGINAL) A housing preform as set forth in claim 1, wherein said interconnects are formed by conductive paste.
5. (ORIGINAL) A housing preform as set forth in claim 1, wherein said plate member is of the shape of the housing unfolded flat.
6. (CURRENTLY AMENDED) An electronic apparatus having a 3D housing comprised of a bent housing preform as set forth in ~~any of claims 1 to 5~~ claim 1.
7. (CURRENTLY AMENDED) An electronic apparatus comprised of a combination of a housing preform as set forth in ~~any of claims 1 to 5~~ claim 1 and system components.

8. (NEW) An electronic apparatus having a 3D housing comprised of a bent housing preform as set forth in claim 2.

9. (NEW) An electronic apparatus having a 3D housing comprised of a bent housing preform as set forth in claim 3.

10. (NEW) An electronic apparatus having a 3D housing comprised of a bent housing preform as set forth in claim 4.

11. (NEW) An electronic apparatus having a 3D housing comprised of a bent housing preform as set forth in claim 5.

12. (NEW) An electronic apparatus comprised of a combination of a housing preform as set forth in claim 2 and system components.

13. (NEW) An electronic apparatus comprised of a combination of a housing preform as set forth in claim 3 and system components.

14. (NEW) An electronic apparatus comprised of a combination of a housing preform as set forth in claim 4 and system components.

15. (NEW) An electronic apparatus comprised of a combination of a housing preform as set forth in claim 2 and system components.